

## **EMBEDDED VISION**

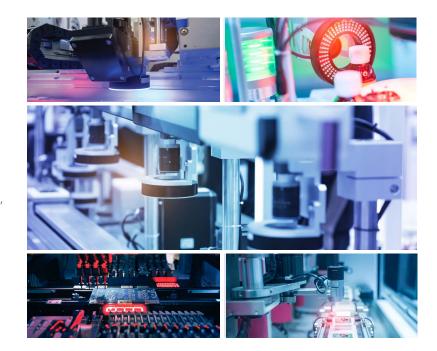
Samtec delivers Sudden Service® solutions that meet the sensor, imaging and data measurement requirements of today's embedded vision applications. Industry-leading expertise in rugged/power and high-performance interconnect systems, combined with on-going Extended Life Product™ and Severe Environment Testing initiatives, enables quick-turn, cost-effective options for the performance, reliability and durability demands of embedded vision applications. For more information, visit samtec.com/embedded-vision or contact SIG@samtec.com.

#### **Product Features & Benefits**

- Signal integrity-optimized solutions
- High-reliability / rugged contact systems
- Small form factors / ultra-high densities
- High frequency interfaces
- Industry standard solutions

## **Design & Development Support**

- Free online tools & resources: 3D Models, Prints, Picture Search & Solutionator® product builders
- Extensive testing initiatives that surpass typical industry standards and specifications
- RF technical support for launch optimization, simulation and test & measurement
- Industry-leading component and system-level engineering expertise





## **Severe Environment Testing**

SET is a Samtec initiative to test products beyond typical industry standards and specifications.

Products undergo additional testing to ensure they are *more than suitable* for military, space, automotive, industrial and other extreme applications.

For additional information and current test results, please visit samtec.com/SET or contact SET@samtec.com.



#### Extended Life Product™

E.L.P.™ products are tested to rigorous standards that evaluate contact resistance in simulated storage and field conditions. These include:

10 year Mixed Flowing Gas (MFG)

High Mating Cycles (250 to 2,500)

For complete details about the E.L.P.™ program and a full list of qualifying products and test results, please visit samtec.com/ELP or contact ASG@samtec.com.

## **RUGGEDIZING SOLUTIONS**

Most Samtec interconnect systems are available with a variety of standard and optional rugged features to ensure quality and durability in any application.

- Jack Screws
- Positive Latching
- Friction Locks
- Retention Pins
- Board Locks
- Weld Tabs
- Guide Posts
- Shielding
- Screw Downs
- Board Standoffs









# **INTERCONNECT SOLUTIONS**

#### **Ultra Micro Interconnects**

Ultra fine pitch connectors featuring low profile and ultra-slim bodies including hermaphroditic interfaces with high-retention Razor Beam™ contacts and EMI shielding.



#### **RF Connectors & Cable Assemblies**

Precision, high frequency/standard and low frequency cable assemblies and connectors supporting sub-6 GHz to 110 GHz microwave/mmWave frequencies.



## Rugged SI Edge Rate® Strips

Signal integrity optimized, high-cycle contacts featuring an extended wipe for a reliable connection in a choice of pitch, stack height and ruggedizing features.



## **High-Performance Arrays**

High-density, extreme performance arrays with an open-pin-field design for maximum routing and grounding flexibility in slim body and low profile designs.



### **Optical Transceivers**

Future-proof, optical transceivers feature a micro footprint providing reliable signal integrity over an extended distance.



## 12G-SDI Broadcast Video

Largest variety of 12G-SDI products: BNC, High-Density BNC and DIN 1.0/2.3 with pick-and-place solutions.



samtec.com/12qsdi

## **CoaXPress® Standard Solutions**

Samtec's compliant high-density BNC 75  $\Omega$  connectors and cable assemblies for high-speed imaging applications.

